



High-end Power Semiconductor Manufacturer

KK3000A 1900V-3000V

Fast Switching Thyristor

- Low switching losses
- Low reverse recovery charge
- Distributed amplified gate for high dI_T/dt



Mean on-state current	I_{TAV}	3000 A
Repetitive peak off-state voltage	V_{DRM}	1900-3000 V
Repetitive peak reverse voltage	V_{RRM}	
Turn-off time	t_q	40.0-110.0 μs
$T_j, ^\circ C$		- 60-125

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Mean on-state current	A	3000 4500	$T_c= 85^\circ C$; Double side cooled; $T_c= 55^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	44.0	$T_j=125^\circ C$	10ms half sine wave $V_R=0.6V_{RRM}$
I^2t	Safety factor	$A^2s \cdot 10^3$	9680.0	$T_j=125^\circ C$	10ms half sine wave $V_R=0.6V_{RRM}$
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1900-3000	$T_j=125^\circ C, t_q=10ms$	

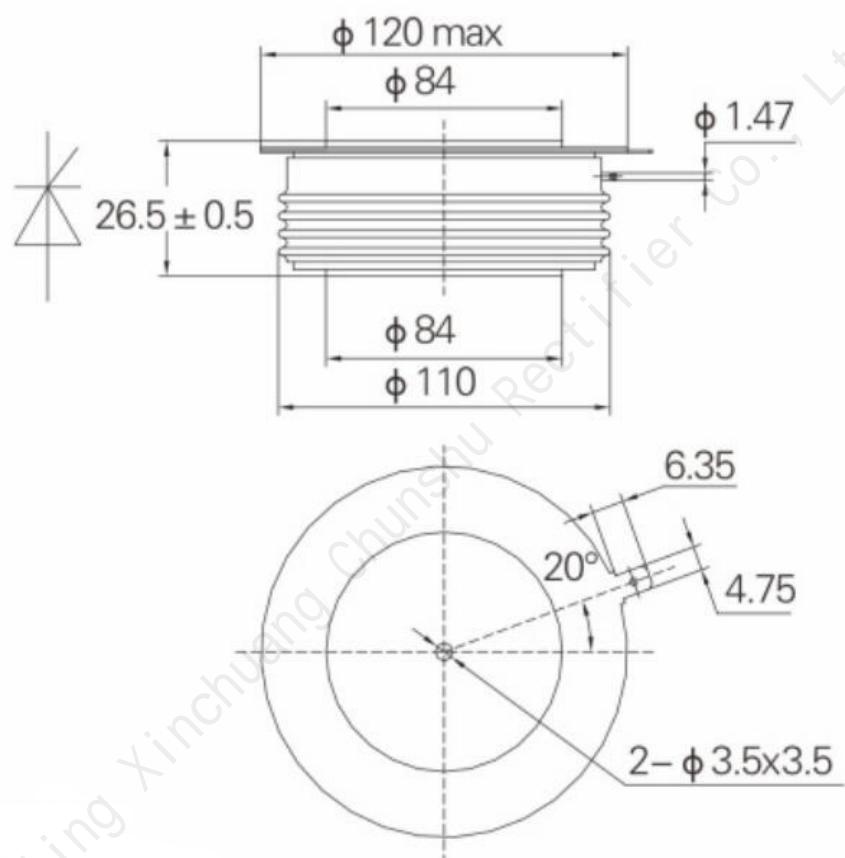
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current	A/ μ s	1200	$V_{DM} = 67\%V_{DRM}$ to 4000A, Gate pulse $t_r \leq 0.5\mu$ s $I_{GM}=1.5$ A
THERMAL				
T_{stg}	Storage temperature	°C	-40-140	
T_j	Operating junction temperature	°C	-60-125	
MECHANICAL				
F	Mounting force	kN	63.0-84.0	

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	3.15	$T_j=25$ °C; $I_{TM}=5000$ A, F=70.0kN	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.32		
r_T	On-state slope resistance, max	$m\Omega$	0.14	$T_j=125$ °C	
I_H	Holding current, max	mA	1000	$V_A=12$ V, $I_A=1$ A	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	250	$T_j=125$ °C $V_D=V_{DRM}$; $V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	1000	$T_j=125$ °C $V_D=0.67\cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage,	V	0.90Min 4.50Max	$T_j=25$ °C	$V_A=12$ V; $I_A=1$ A;
I_{GT}	Gate trigger direct current,	mA	40Min 450Max	$T_j=25$ °C	
V_{GD}	Gate non-trigger direct voltage, min	V	0.30	$T_j=125$ °C ; $V_D=0.67\cdot V_{DRM}$;	
SWITCHING					
t_q	Turn-off time ²⁾ ,	μ s	40.0Min	$I_{TM}=2000$ A, $t_p=1000\mu$ s, $V_R = 50$ V	
			120.0Max	$dv/dt=30V/\mu$ s , $di/dt=-20A/\mu$ s	
Q_{rr}	Total recovered charge, max	μ C	2100	$T_j=125$ °C ; $I_{TM}=2000$ A, $t_p=2000\mu$ s, $di/dt=-60A/\mu$ s, $V_R=50$ V	

THERMAL

R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.007	At 180°sine, double side cooled Clamping force 70.0kN
R_{thch}	Thermal resistance, case to heatsink, max	°C/W	0.002	
MECHANICAL				
w	Weight, typ	g	1390	

OVERALL DIMENSIONS

All dimensions in millimeters

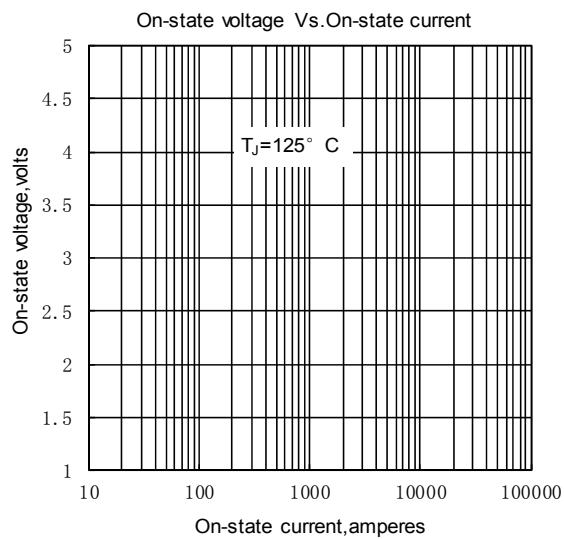


Fig. 1

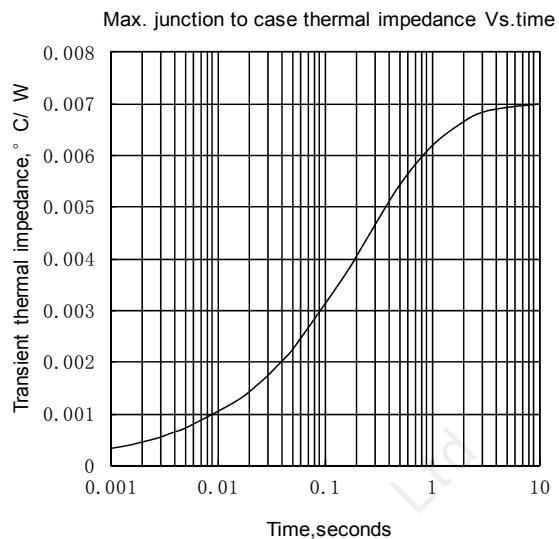


Fig. 2

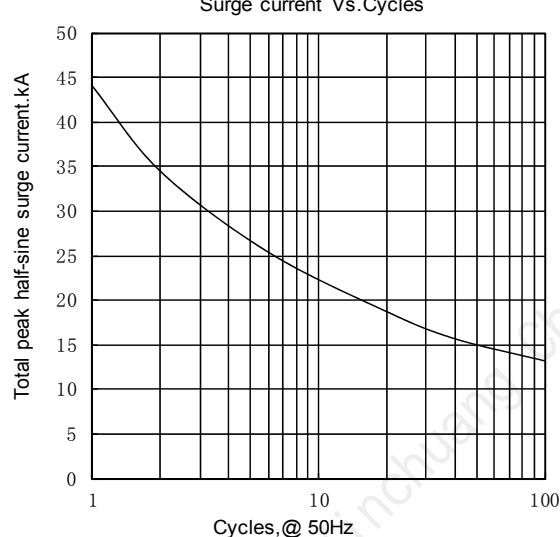


Fig. 3

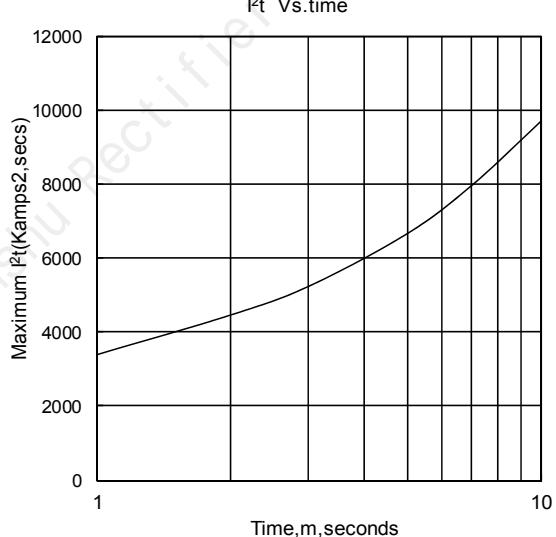


Fig. 4

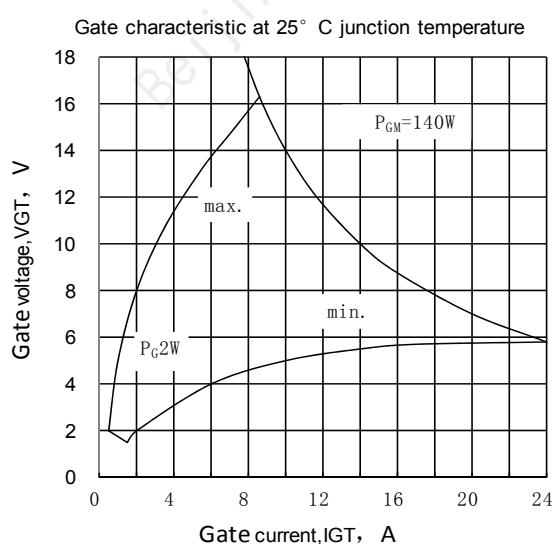


Fig. 5

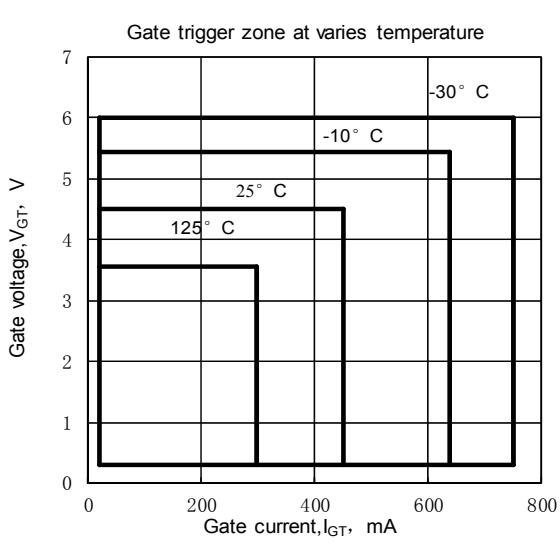


Fig. 6